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March 2010

FSGM0765R Green-Mode Fairchild Power Switch (FPS™)

Features

- Soft Burst-Mode Operation for Low Standby Power Consumption and Low Noise
- Precision Fixed Operating Frequency: 66kHz
- Pulse-by-Pulse Current Limit
- Various Protection Functions: Overload Protection (OLP), Over-Voltage Protection (OVP), Abnormal Over-Current Protection (AOCP), Internal Thermal Shutdown (TSD) with Hysteresis, Output-Short Protection (OSP), and Under-Voltage Lockout (UVLO) with Hysteresis
- Auto-Restart Mode
- Internal Startup Circuit
- Internal High-Voltage SenseFET: 650V
- Built-in Soft-Start: 15ms

Ordering Information

Applications

 Power Supply for LCD TV and Monitor, STB and DVD Combination

Description

The FSGM0765R is an integrated Pulse Width Modulation (PWM) controller and SenseFET specifically designed for offline Switch-Mode Power Supplies (SMPS) with minimal external components. The PWM controller includes an integrated fixed-frequency oscillator, Under-Voltage Lockout (UVLO), Leading-Edge Blanking (LEB), optimized gate driver, internal soft-start, temperature-compensated precise current sources for loop compensation, and self-protection circuitry. Compared with a discrete MOSFET and PWM controller solution, the FSGM series can reduce total cost, component count, size, and weight; while simultaneously increasing efficiency, productivity, and system reliability. This device provides a basic platform suited for cost-effective design of a flyback converter.

kage T	Operating Junction	Current	Recon			ver Table ⁽²⁾		
•		Current	RECON					
•	ounction			230V _{AC} ± 15% ⁽³⁾		85~265V _{AC}		Replaces
	Femperature	Limit (Max.)			Open Frame ⁽⁵⁾	Adapter ⁽⁴⁾	Open Frame ⁽⁵⁾	Device
ad ⁽¹⁾	-40°C ~ +125°C	2.60A	1.6Ω	80W	90W	48W	70W	FSDM07652RE
ad ⁽¹⁾	-40°C ~ +125°C	2.60A	1.6Ω	80W	90W	48W	70W	FSDM07652RE
ad ⁽¹⁾	-40°C ~ +125°C	2.60A	1.6Ω	80W	90W	48W	70W	FSDM07652RE
	220F ad ⁽¹⁾ rming 220F ad ⁽¹⁾ rming 220F ad ⁽¹⁾ ming	$\begin{array}{c c} -40^{\circ}C &\sim \\ \hline ming &+125^{\circ}C \\ \hline 220F \\ ad^{(1)} &-40^{\circ}C &\sim \\ +125^{\circ}C \\ \hline 220F \\ ad^{(1)} &+125^{\circ}C \\ \hline &+125^{\circ}C \\ \hline &+125^{\circ}C \\ \hline \end{array}$	$\begin{array}{c cccc} ad^{(1)} & -40^{\circ}C \\ ming & +125^{\circ}C \\ \hline 220F \\ ad^{(1)} & -40^{\circ}C \\ +125^{\circ}C \\ \hline 220F \\ ad^{(1)} & -40^{\circ}C \\ +125^{\circ}C \\ \hline 2.60A \\ \hline 2.60$	$\begin{array}{c c} 220F \\ ad^{(1)} \\ ming \\ 220F \\ ad^{(1)} \\ ming \\ 220F \\ ad^{(1)} \\ +125^{\circ}C \\ +125^{\circ}C \\ 2.60A \\ 1.6\Omega \\ 1.6\Omega \\ 220F \\ ad^{(1)} \\ +125^{\circ}C \\ 2.60A \\ 1.6\Omega \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

Notes:

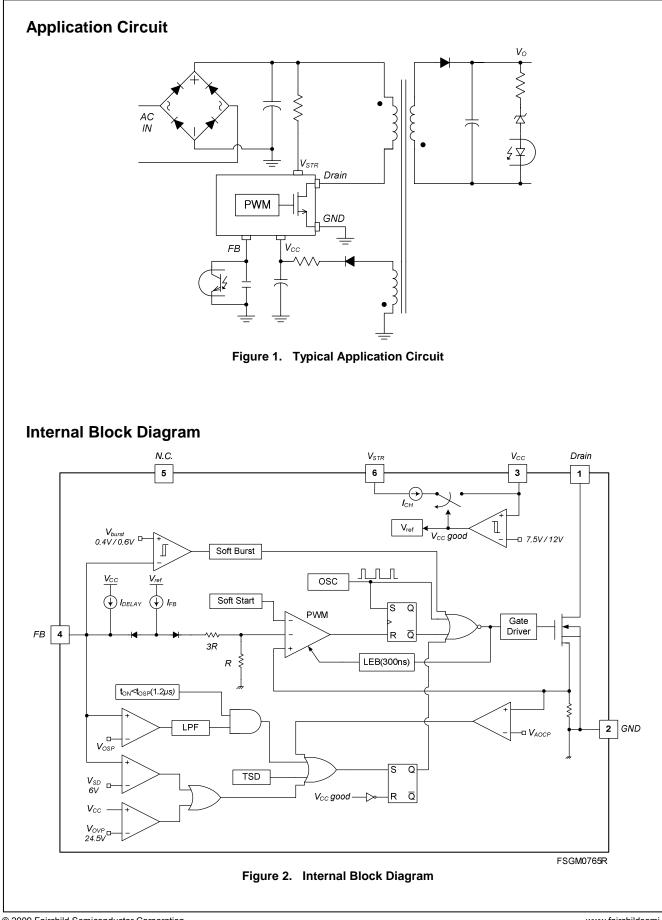
- 1. Pb-free package per JEDEC J-STD-020B.
- 2. The junction temperature can limit the maximum output power.
- 3. $230V_{AC}$ or $100/115V_{AC}$ with voltage doubler.
- 4. Typical continuous power in a non-ventilated enclosed adapter measured at 50°C ambient temperature.
- 5. Maximum practical continuous power in an open-frame design at 50°C ambient temperature.



FSGM0765R

— Green-Mode Fairchild Power Switch (FPS[™])





6. V_{STR} 5. N.C. 4. FB 3. V_{CC} 2. GND 1. Drain

FSGM0765R



Pin Definitions

Pin Configuration

Pin #	Name	Description
1	Drain	SenseFET Drain. High-voltage power SenseFET drain connection.
2	GND	Ground. This pin is the control ground and the SenseFET source.
3	Vcc	Power Supply . This pin is the positive supply input, which provides the internal operating current for both startup and steady-state operation.
4 FB Feedback . This pin is internally connected to the inverting input of the PWM com The collector of an opto-coupler is typically tied to this pin. For stable operation, a should be placed between this pin and GND. If the voltage of this pin reaches 6V		Feedback . This pin is internally connected to the inverting input of the PWM comparator. The collector of an opto-coupler is typically tied to this pin. For stable operation, a capacitor should be placed between this pin and GND. If the voltage of this pin reaches 6V, the overload protection triggers, which shuts down the FPS.
5	N.C.	No Connection.
6	V _{STR}	Startup . This pin is connected directly, or through a resistor, to the high-voltage DC link. At startup, the internal high-voltage current source supplies internal bias and charges the external capacitor connected to the V_{CC} pin. Once V_{CC} reaches 12V, the internal current source (I_{CH}) is disabled.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Min.	Max.	Unit		
V _{STR}	V _{STR} Pin Voltage				650	V
V _{DS}	Drain Pin Voltage				650	V
V _{CC}	V _{CC} Pin Voltage				26	V
V _{FB}	Feedback Pin Voltage			-0.3	12.0	V
I _{DM}	Drain Current Pulsed				12.8	А
	Cantinuaus Quitabing	T _C =+25°C		6.4	А	
I _{DS}	Continuous Switching	T _c =+100°C			4.0	А
E _{AS}	Single Pulsed Avalance	Pulsed Avalanche Energy ⁽⁷⁾			390	mJ
PD	Total Power Dissipation			45	W	
-	Maximum Junction Te			+150	°C	
TJ	Operating Junction Te		-40	+125	°C	
T _{STG}	Storage Temperature	-55	+150	°C		
VISO	Minimum Isolation Voltage ⁽¹⁰⁾			2.5		V
500	Electrostatic	Electrostatic Discharge Capability Human Body Model, JESD22-A114 Charged Device Model, JESD22-C101				1.3.7
ESD	Discharge Capability					- kV

Notes:

6. Repetitive peak switching current when the inductive load is assumed: Limited by maximum duty (D_{MAX}=0.75) and junction temperature (see Figure 4).

7. L=70mH, starting T_J=+25°C.

8. Infinite cooling condition (refer to the SEMI G30-88).

- 9. Although this parameter guarantees IC operation, it does not guarantee all electrical characteristics.
- 10. The voltage between the package back side and the lead is guaranteed.

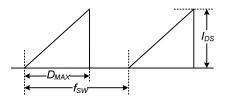


Figure 4. Repetitive Peak Switching Current

Thermal Impedance

T_A=25°C unless otherwise specified.

Symbol	Parameter		Unit
θ _{JA}	Junction-to-Ambient Thermal Impedance ⁽¹¹⁾		°C/W
θ _{JC}	Junction-to-Case Thermal Impedance ⁽¹²⁾	3	°C/W

Notes:

11. Infinite cooling condition (refer to the SEMI G30-88).

12. Free standing with no heat-sink under natural convection.

Electrical Characteristics

 T_J =+25°C unless otherwise specified.

Symbol	Parameter		Conditions	Min.	Тур.	Max.	Unit
SenseFET	Section			•			
BV _{DSS}	Drain-Source Br	eakdown Voltage	V _{CC} =0V, I _D =250μA	650			V
I _{DSS}	Zero-Gate-Voltage Drain Current		V _{DS} =520V, T _A =+125°C			250	μA
R _{DS(ON)}	Drain-Source Or	n-State Resistance	V _{GS} =10V, I _D =1A		1.3	1.6	Ω
CISS	Input Capacitan	ce ⁽¹³⁾	V _{DS} =25V, V _{GS} =0V, f=1MHz		674		pF
C _{OSS}	Output Capacita	nce ⁽¹³⁾	V _{DS} =25V, V _{GS} =0V, f=1MHz		93		pF
tr	Rise Time		V _{DS} =325V, I _D =4A, R _G =25Ω		30		ns
t _f	Fall Time		V_{DS} =325V, I_{D} =4A, R_{G} =25 Ω		26		ns
t _{d(on)}	Turn-On Delay T	īme	V _{DS} =325V, I _D =4A, R _G =25Ω		16		ns
t _{d(off)}	Turn-Off Delay T	īme	V _{DS} =325V, I _D = 4A, R _G =25Ω		39		ns
Control Sec	ction						
f _S	Switching Frequ	ency	V _{CC} =14V, V _{FB} =4V	60	66	72	kHz
Δf_S	Switching Frequ	ency Variation ⁽¹³⁾	- 25°C < TJ < +125°C		±5	±10	%
D _{MAX}	Maximum Duty F	Ratio	V _{CC} =14V, V _{FB} =4V	65	70	75	%
D _{MIN}	Minimum Duty Ratio		V _{CC} =14V, V _{FB} =0V			0	%
I _{FB}	Feedback Source Current		V _{FB} =0	160	210	260	μA
V _{START}			V _{FB} =0V, V _{CC} Sweep	11	12	13	V
V _{STOP}	UVLO Threshold Voltage		After Turn-on, V _{FB} =0V	7.0	7.5	8.0	V
V _{OP}	V _{CC} Operating Range			13		23	V
t _{S/S}	Internal Soft-Start Time		V _{STR} =40V, V _{CC} Sweep		15		ms
Burst-Mode	e Section						
V _{BURH}				0.5	0.6	0.7	V
V _{BURL}	Burst-Mode Volt	age	V _{CC} =14V, V _{FB} Sweep	0.3	0.4	0.5	V
Hys	-				200		mV
Protection	Section		I				
ILIM	Peak Drain Curr	ent Limit	di/dt=300mA/µs	2.37	2.60	2.83	А
V_{SD}	Shutdown Feedl	oack Voltage	V _{CC} =14V, V _{FB} Sweep	5.5	6.0	6.5	V
IDELAY	Shutdown Delay Current		V _{CC} =14V, V _{FB} =4V	2.5	3.3	4.1	μA
t_{LEB}	Leading-Edge B	lanking Time ⁽¹³⁾⁽¹⁴⁾			300		ns
V _{OVP}	Over-Voltage Pr		V _{CC} Sweep	23.0	24.5	26.0	V
t _{OSP}		Threshold Time		1.0	1.2	1.4	μS
V _{OSP}	Output Short Protection ⁽¹³⁾	Threshold V _{FB}	OSP Triggered when t _{ON} <t<sub>OSP & V_{FB}>V_{OSP}</t<sub>	1.8	2.0	2.2	V
t _{OSP_FB}		V _{FB} Blanking Time	(Lasts Longer than t _{OSP_FB})	2.0	2.5	3.0	μS
T _{SD}	-	- (13)	Shutdown Temperature	+130	+140	+150	°C
Hys	- Thermal Shutdo	wn Temperature ⁽¹³⁾	Hysteresis		+30		°C

Continued on the following page...

Electrical Characteristics (Continued)

 T_J =+25°C unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit		
Total Device Section								
I _{OP}	Operating Supply Current, (Control Part in Burst Mode)			1.6	2.0	mA		
I _{OPS}	Operating Switching Current, (Control Part and SenseFET Part)	V _{CC} =14V, V _{FB} =4V	2.0	2.5	3.0	mA		
ISTART	Start Current	V _{CC} =11V (Before V _{CC} Reaches V _{START})	0.5	0.6	0.7	mA		
I _{CH}	Startup Charging Current	$V_{CC}=V_{FB}=0V, V_{STR}=40V$	1.00	1.15	1.30	mA		
V _{STR}	Minimum VSTR Supply Voltage	$V_{CC}=V_{FB}=0V$, V_{STR} Sweep		26		V		

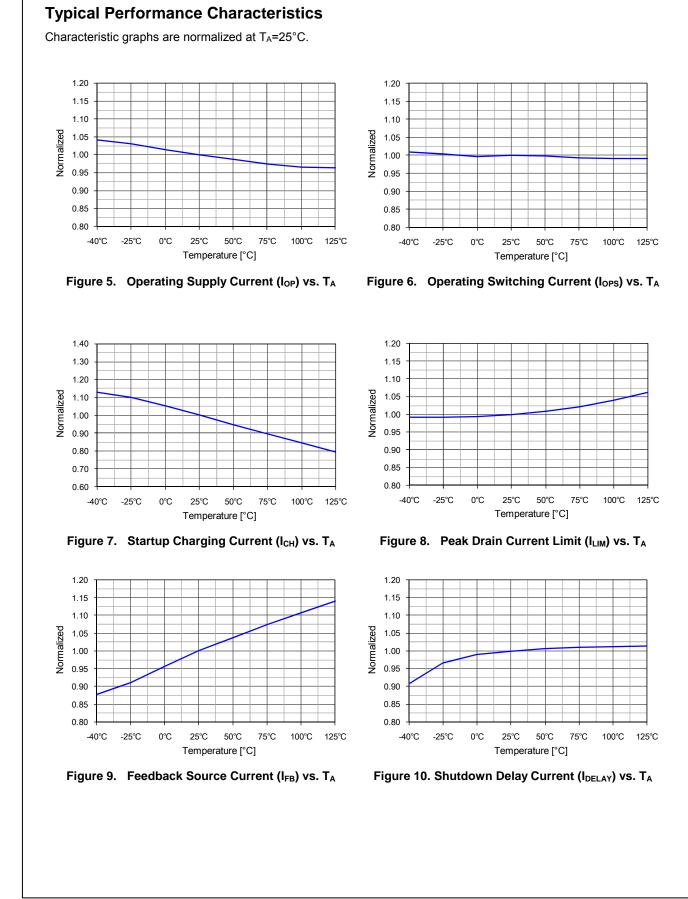
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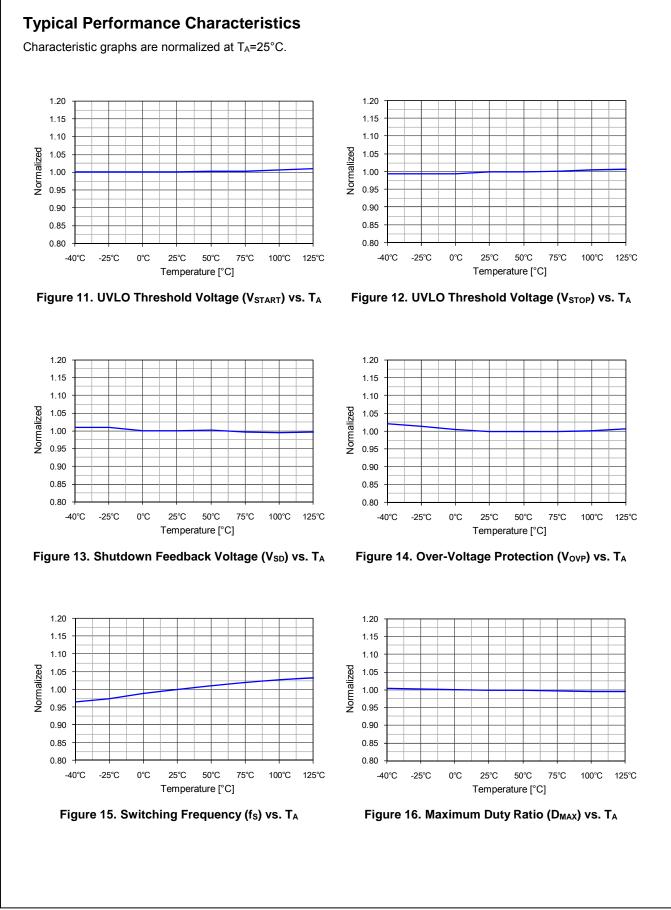
13. Although these parameters are guaranteed, they are not 100% tested in production.

14. t_{LEB} includes gate turn-on time.

Comparison of FSDM07652RE and FSGM0765R

Function	FSDM07652RE FSGM0765R		Advantages of FSGM0765R
Burst Mode	Advanced Burst	Advanced Soft Burst	Low noise and low standby power
Lightning Surge		Strong	Enhanced SenseFET and controller against lightning surge
Soft-Start	10ms (Built-in)	15ms (Built-in)	Longer soft-start time
		OLP	
	OLP	OVP	
Protections	OVP	OSP	Enhanced protections and high reliability
	TSD	AOCP	
		TSD with Hysteresis	
Power Balance	Long T _{CLD}	Very Short T _{CLD}	The difference of input power between the low and high input voltage is quite small





Functional Description

1. Startup: At startup, an internal high-voltage current source supplies the internal bias and charges the external capacitor (C_{Vcc}) connected to the V_{CC} pin, as illustrated in Figure 17. When V_{CC} reaches 12V, the FSGM0765R begins switching and the internal high-voltage current source is disabled. The FSGM0765R continues normal switching operation and the power is supplied from the auxiliary transformer winding unless V_{CC} goes below the stop voltage of 7.5V.

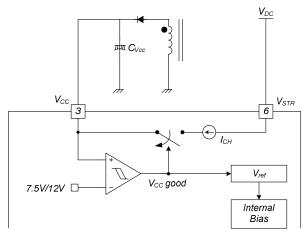
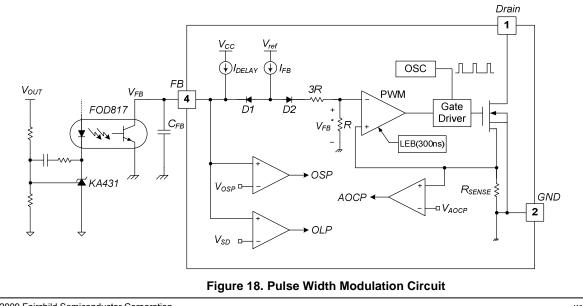


Figure 17. Startup Block

2. Soft-Start: The FSGM0765R has an internal softstart circuit that increases PWM comparator inverting input voltage, together with the SenseFET current, slowly after it starts. The typical soft-start time is 15ms. The pulse width to the power switching device is progressively increased to establish the correct working conditions for transformers, inductors, and capacitors. The voltage on the output capacitors is progressively increased to smoothly establish the required output voltage. This helps prevent transformer saturation and reduces stress on the secondary diode during startup. **3. Feedback Control**: This device employs currentmode control, as shown in Figure 18. An opto-coupler (such as the FOD817) and shunt regulator (such as the KA431) are typically used to implement the feedback network. Comparing the feedback voltage with the voltage across the R_{SENSE} resistor makes it possible to control the switching duty cycle. When the reference pin voltage of the shunt regulator exceeds the internal reference voltage of 2.5V, the opto-coupler LED current increases, pulling down the feedback voltage and reducing drain current. This typically occurs when the input voltage is increased or the output load is decreased.

3.1 Pulse-by-Pulse Current Limit: Because currentmode control is employed, the peak current through the SenseFET is limited by the inverting input of PWM comparator (V_{FB}*), as shown in Figure 18. Assuming that the 210 μ A current source flows only through the internal resistor (3R + R = 11.6k Ω), the cathode voltage of diode D2 is about 2.4V. Since D1 is blocked when the feedback voltage (V_{FB}) exceeds 2.4V, the maximum voltage of the cathode of D2 is clamped at this voltage. Therefore, the peak value of the current through the SenseFET is limited.

3.2 Leading-Edge Blanking (LEB): At the instant the internal SenseFET is turned on, a high-current spike usually occurs through the SenseFET, caused by primary-side capacitance and secondary-side rectifier reverse recovery. Excessive voltage across the R_{SENSE} resistor leads to incorrect feedback operation in the current mode PWM control. To counter this effect, the FSGM0765R employs a leading-edge blanking (LEB) circuit. This circuit inhibits the PWM comparator for t_{LEB} (300ns) after the SenseFET is turned on.



4. Protection Circuits: The FSGM0765R has several self-protective functions, such as Overload Protection (OLP), Abnormal Over-Current Protection (AOCP), Output-Short Protection (OSP), Over-Voltage Protection (OVP), and Thermal Shutdown (TSD). All the protections are implemented as auto-restart. Once the fault condition is detected, switching is terminated and the SenseFET remains off. This causes Vcc to fall. When V_{CC} falls to the Under-Voltage Lockout (UVLO) stop voltage of 7.5V, the protection is reset and the startup circuit charges the V_{CC} capacitor. When V_{CC} reaches the start voltage of 12.0V, the FSGM0765R resumes normal operation. If the fault condition is not removed, the SenseFET remains off and V_{CC} drops to stop voltage again. In this manner, the auto-restart can alternately enable and disable the switching of the power SenseFET until the fault condition is eliminated. Because these protection circuits are fully integrated into the IC without external components, the reliability is improved without increasing cost.

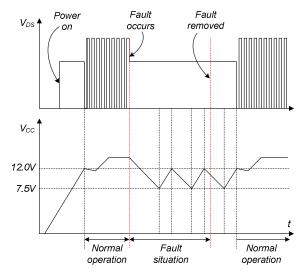
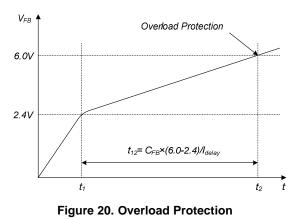


Figure 19. Auto-Restart Protection Waveforms

4.1 Overload Protection (OLP): Overload is defined as the load current exceeding its normal level due to an unexpected abnormal event. In this situation, the protection circuit should trigger to protect the SMPS. However, even when the SMPS is in normal operation, the overload protection circuit can be triggered during the load transition. To avoid this undesired operation, the overload protection circuit is designed to trigger only after a specified time to determine whether it is a transient situation or a true overload situation. Because of the pulse-by-pulse current limit capability, the maximum peak current through the SenseFET is limited and, therefore, the maximum input power is restricted with a given input voltage. If the output consumes more than this maximum power, the output voltage (V_{OUT}) decreases below the set voltage. This reduces the current through the opto-coupler LED, which also reduces the opto-coupler transistor current, thus increasing the feedback voltage (V_{FB}). If V_{FB} exceeds 2.4V, D1 is blocked and the 3.3µA current source starts to charge C_{FB} slowly up. In this condition, V_{FB} continues

increasing until it reaches 6.0V, when the switching operation is terminated, as shown in Figure 20. The delay time for shutdown is the time required to charge C_{FB} from 2.4V to 6.0V with 3.3μ A. A 25 ~ 50ms delay is typical for most applications. This protection is implemented in auto-restart mode.



4.2 Abnormal Over-Current Protection (AOCP): When the secondary rectifier diodes or the transformer pins are shorted, a steep current with extremely high di/dt can flow through the SenseFET during the minimum turn-on time. Even though the FSGM0765R has overload protection, it is not enough to protect the FSGM0765R in that abnormal case; since severe current stress is imposed on the SenseFET until OLP is triggered. The FSGM0765R internal AOCP circuit is shown in Figure 21. When the gate turn-on signal is applied to the power SenseFET, the AOCP block is enabled and monitors the current through the sensing resistor. The voltage across the resistor is compared with a preset AOCP level. If the sensing resistor voltage is greater than the AOCP level, the set signal is applied to the S-R latch, resulting in the shutdown of the SMPS.

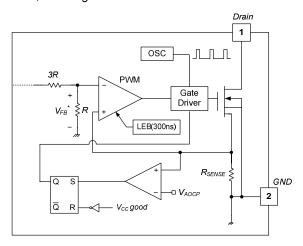
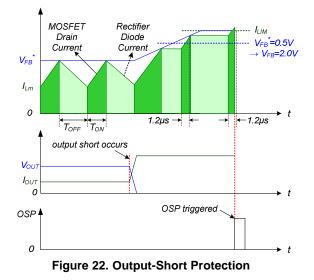


Figure 21. Abnormal Over-Current Protection

4.3. Output-Short Protection (OSP): If the output is shorted, steep current with extremely high di/dt can flow through the SenseFET during the minimum turnon time. Such a steep current brings high-voltage stress on the drain of the SenseFET when turned off. To protect the device from this abnormal condition, OSP is included. It is comprised of detecting V_{FB} and SenseFET turn-on time. When the V_{FB} is higher than 2V and the SenseFET turn-on time is lower than 1.2μ s, the FSGM0765R recognizes this condition as an abnormal error and shuts down PWM switching until V_{CC} reaches V_{START} again. An abnormal condition output short is shown in Figure 22.



4.4 Over-Voltage Protection (OVP): If the secondary-side feedback circuit malfunctions or a solder defect causes an opening in the feedback path, the current through the opto-coupler transistor becomes almost zero. Then V_{FB} climbs up in a similar manner to the overload situation, forcing the preset maximum current to be supplied to the SMPS until the overload protection is triggered. Because more energy than required is provided to the output, the output voltage may exceed the rated voltage before the overload protection is triggered, resulting in the breakdown of the devices in the secondary side. To prevent this situation, an OVP circuit is employed. In general, the V_{CC} is proportional to the output voltage and the FSGM0765R uses V_{CC} instead of directly monitoring the output voltage. If V_{CC} exceeds 24.5V, an OVP circuit is triggered, resulting in the termination of the switching operation. To avoid undesired activation of OVP during normal operation, V_{CC} should be designed to be below 24.5V.

4.5 Thermal Shutdown (TSD): The SenseFET and the control IC on a die in one package makes it easier for the control IC to detect the over temperature of the SenseFET. If the temperature exceeds ~140°C, the thermal shutdown is triggered and the FSGM0765R stops operation. The FSGM0765R operates in auto-restart mode until the temperature decreases to around 110°C, when normal operation resumes.

5. Soft Burst-Mode Operation: To minimize power dissipation in standby mode, the FSGM0765R enters burst-mode operation. As the load decreases, the feedback voltage decreases. As shown in Figure 23, the device automatically enters burst mode when the feedback voltage drops below VBURI (400mV). At this point, switching stops and the output voltages start to drop at a rate dependent on standby current load. This causes the feedback voltage to rise. Once it passes V_{BURH} (600mV), switching resumes. At this point, the drain current peak increases gradually. This soft burstmode can reduce audible noise during burst-mode operation. The feedback voltage then falls and the process repeats. Burst-mode operation alternately enables and disables switching of the SenseFET, thereby reducing switching loss in standby mode.

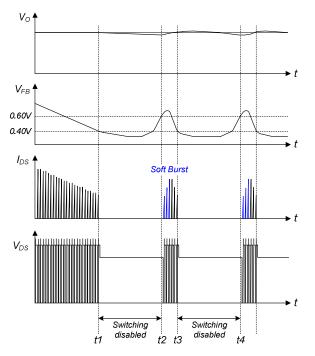


Figure 23. Burst-Mode Operation

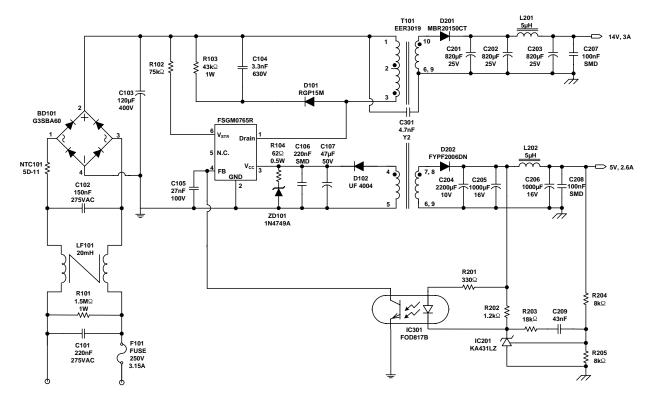
Typical Application Circuit

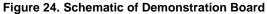
Application	Input Voltage	Rated Output	Rated Power
LCD TV, Monitor Power Supply	85 ~ 265V _{AC}	5.0V(2.6A) 12.0V(3.0A)	55W

Key Design Notes:

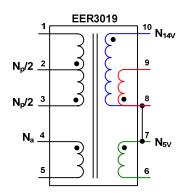
- 1. The delay time for overload protection is designed to be about 30ms with C105 (27nF). OLP time between 25ms (22nF) and 50ms (43nF) is recommended.
- The SMD-type capacitor (C106) must be placed as close as possible to the V_{CC} pin to avoid malfunction by abrupt pulsating noises and to improve ESD and surge immunity. Capacitance between 100nF and 220nF is recommended.

1. Schematic





2. Transformer



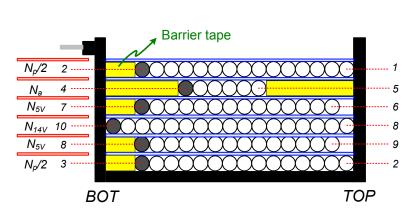


Figure 25. Schematic of Transformer

3. Winding Specification

		Pin (S \rightarrow F) Wire		Turne Winding Mothed		arrier Tape	e
	Pin (S → F)	wire	Turns	Winding Method	ТОР	вот	Ts
N _p /2	$3 \rightarrow 2$	0.37φ×1	20	Solenoid Winding		2.0mm	1
Insulation: Polyes	ster Tape t=0.025r	nm, 2 Layers					
N _{5V}	8 → 9	0.4φ×3 (TIW)	3	Solenoid Winding		2.0mm	1
Insulation: Polyes	ter Tape t=0.025r	nm, 2 Layers					
N _{14V}	$10 \rightarrow 8$	0.4φ×3 (TIW)	5	Solenoid Winding			
Insulation : Polyes	ster Tape t=0.025	mm, 2 Layers					
N _{5V}	$7 \rightarrow 6$	0.4φ×3 (TIW)	3	Solenoid Winding		2.0mm	1
Insulation: Polyes	Insulation: Polyester Tape t=0.025mm, 2 Layers						
Na	$4 \rightarrow 5$	0.2φ×1	6	Solenoid Winding	4.0mm	4.0mm	1
Insulation: Polyes							
N _p /2	$2 \rightarrow 1$	0.37φ×1	20	Solenoid Winding		2.0mm	1
Insulation: Polyester Tape t=0.025mm, 2 Layers							

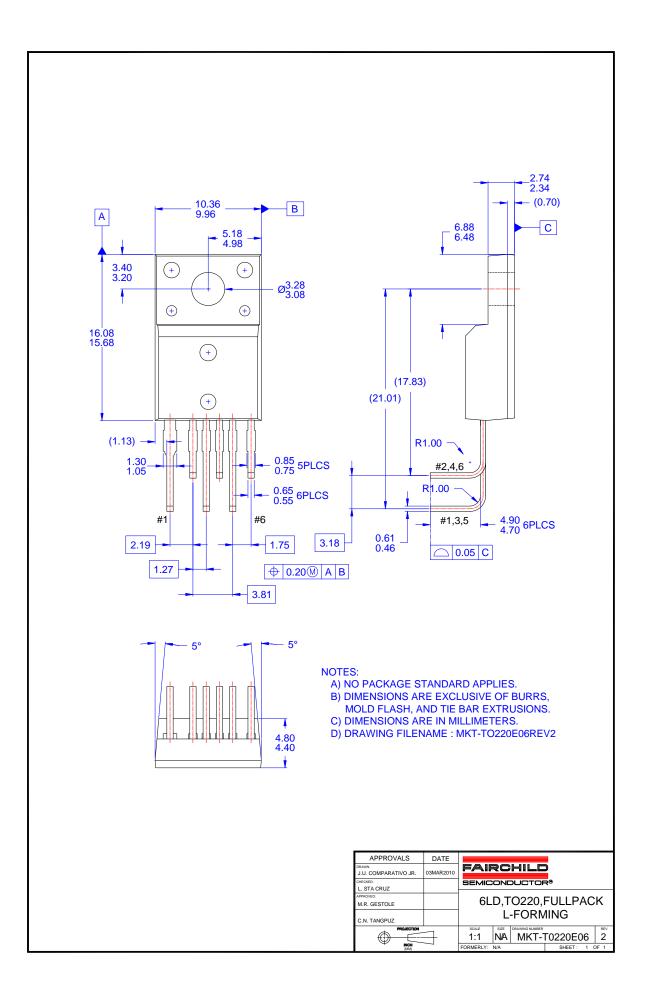
4. Electrical Characteristics

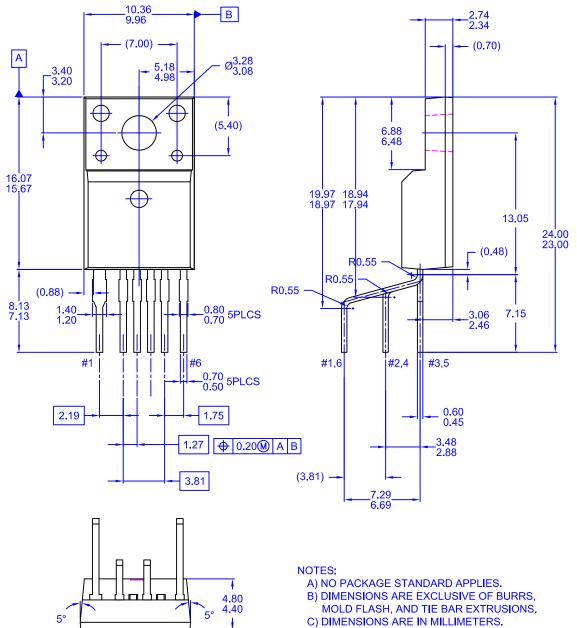
	Pin	Specification	Remark	
Inductance	1-3	670μH ± 7%	67kHz, 1V	
Leakage	1-3	15μH Maximum	Short All Other Pins	

5. Core & Bobbin

- Core: EER3019 (Ae=134.0mm²)
- Bobbin: EER3019

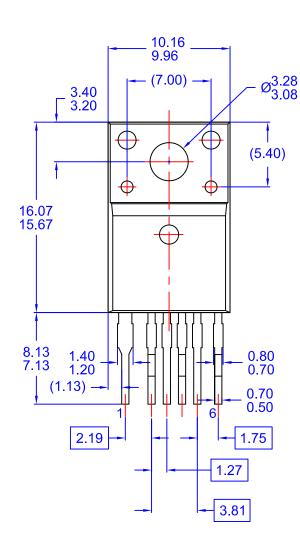
Part #	Value	Note	Part #	Value	Note	
	Fuse		Capacitor			
F101 250V 3.15A		C101	220nF/275V	Box (Pilkor)		
	NTC		C102	150nF/275V	Box (Pilkor)	
NTC101	5D-11	DSC	C103	120µF/400V	Electrolytic (SamYoung	
	Resistor		C104	3.3nF/630V	Film (Sehwa)	
R101	1.5MΩ, J	0.5W	C105	27nF/100V	Film (Sehwa)	
R102	75kΩ, J	1/2W	C106	220nF	SMD (2012)	
R103	43kΩ, J	1W	C107	47μF/50V	Electrolytic (SamYoung	
R104	62Ω, J	1/2W	C201	820μF/25V	Electrolytic (SamYoung	
R201	330Ω, J	1/4W	C202	820μF/25V	Electrolytic (SamYoung	
R202	1.2kΩ, F	1/4W, 1%	C203	820μF/25V	Electrolytic (SamYoung	
R203	18kΩ, F	1/4W, 1%	C204	2200μF/10V	Electrolytic (SamYoung	
R204	8kΩ, F	1/4W, 1%	C205	1000μF/16V	Electrolytic (SamYoung	
R205	8kΩ, F	1/4W, 1%	C206	1000μF/16V	Electrolytic (SamYoung	
	IC		C207	47nF/100V	Film (Sehwa)	
FSGM0765R	FSGM0765R	Fairchild Semiconductor	C208	100nF	SMD (2012)	
IC201	KA431LZ	Fairchild Semiconductor	C209	100nF	SMD (2012)	
IC301	FOD817B	Fairchild Semiconductor	C301	4.7nF/Y2	Y-cap (Samhwa)	
	Diode			Inducto	or	
D101	RGP15M	Vishay	LF101	20mH	Line filter 0.7Ø	
D102	UF4004	Vishay	L201	5μH	5A Rating	
ZD101	1N4749	Vishay	L202	5μΗ	5A Rating	
D201 MBR20150CT Fairchild Semiconductor		Jumper				
D202	FYPF2006DN	Fairchild Semiconductor	J101			
BD101	G3SBA60	Vishay		Transfor	mer	
			T101	670μH		

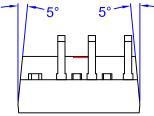


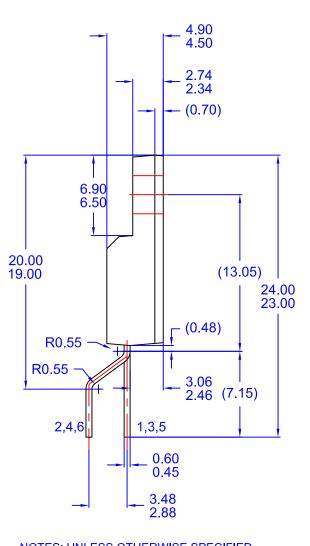


D) DRAWING FILENAME : MKT-TO220F06REV3









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